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Product Change Notification - RMES-20KKZC335

Date: 06 Jul 2016

Product Category:

Notification subject: CCB 2642 Initial Notice: Qualification of GTK assembly site for selected Supertex products

available in 3L TO-92 package.

Notification text: PCN Status:

Initial notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of GTK assembly site for selected Supertex products using Non-Au backside coating available in the 3L TO-92 package.

Pre Change:

CRTK assembly site

Post Change:

GTK assembly site

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	CRTK	GTK
Wire material	Au wire	Au wire
Die attach material	84-1 LMISR4	CRM-1076DJ-G
Molding compound material	G600	G600
Lead frame material	KFC	A194
Lead frame Paddle size	105 x 100 mils	105 x 88 mils

Impacts to Data Sheet:

None

Reason for Change:

To improve productivity and on-time delivery performance by qualifying GTK assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date.

Summary Table:

	June 2016		>			August 2016						
Work Week	22	23	24	25					31	32	33	34
Initial PCN Issue Date	х											
Qualification Report Availability												Х
Final PCN Issue Date												Х

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

May 31, 2016: Issued initial notification.

July 6, 2016: Re-issued the initial notification to notify all affected customers.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): PCN_RMES-20KKZC335_Affected_CPN.pdf

PCN_RMES-20KKZC335_Qual Plan.pdf

PCN_RMES-20KKZC335_Affected_CPN.xlsx

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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Affected Catalog Part Number

PCN_RMES-20KKZC335
CATALOG_PART_NBR
HV9921N3-G
HV9922N3-G
HV9923N3-G
LR12N3-G
LR645N3-G
LR645N3-G-P003
LR645N3-G-P013
LR745N3-G
LR745N3-G-P003
LR745N3-G-P013
LR8N3-G
LR8N3-G-P003